

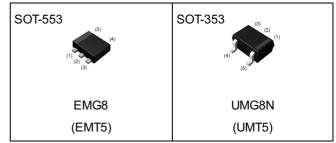
## Emitter common (dual digital transistor)

Parameter	DTr1 and DTr2
V <sub>CC</sub>	50V
I <sub>C(MAX.)</sub>	100mA
R <sub>1</sub>	4.7kΩ
R <sub>2</sub>	47kΩ

#### Features

- 1)Two DTC143Z chips in a EMT or UMT package.
- 2) Mounting cost and area can be cut in half.

#### Outline



#### •Inner circuit

(1) DTr1 IN(Base) (5) (4)
(2) DTr1 / DTr2
GND(Emitter) (3) DTr2 IN(Base)
(4) DTr2 OUT(Collector) (5) DTr1 OUT(Collector) (1) (2) (3)

## Application

INVERTER, INTERFACE, DRIVER

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMG8	SOT-553 (EMT5)	1616	T2R	180	8	8000	G8
UMG8N	SOT-353 (UMT5)	2021	TR	180	8	3000	G8

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

Parameter		Symbol	Values	Unit
Supply voltage		V <sub>CC</sub>	50	V
Input voltage		V <sub>IN</sub>	-5 to 30	V
Output current		Io	100	mA
Collector current	ector current		100	mA
Davis a dia sin ation	EMG8	P <sub>D</sub> *2*3	150	::::\\//T- t-
Power dissipation UMG8N		P <sub>D</sub> *2*3	150	mW/Total
Junction temperature		T <sub>j</sub>	150	°C
Range of storage temperature		T <sub>stg</sub>	-55 to +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

Darameter	Cumbal	Conditions	Values			Lloit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
lanut valtaga	$V_{I(off)}$	$V_{CC} = 5V, I_{O} = 100 \mu A$	-	-	0.5	V
Input voltage	V <sub>I(on)</sub>	$V_{O} = 0.3V, I_{O} = 5mA$	1.3	-	-	V
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = 5mA, I <sub>I</sub> = 250μA	-	100	300	mV
Input current	I <sub>I</sub>	V <sub>I</sub> = 5V	-	-	1.8	mA
Output current	I <sub>O(off)</sub>	V <sub>CC</sub> = 50V, V <sub>I</sub> = 0V	-	-	500	nA
DC current gain	G <sub>I</sub>	V <sub>O</sub> = 5V, I <sub>O</sub> = 10mA	80	-	-	-
Input resistance	R <sub>1</sub>	-	3.29	4.7	6.11	kΩ
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>	-	8	10	12	-
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	-	250	-	MHz

<sup>\*1</sup> Characteristics of built-in transistor.

<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3 120</sup>mW per element must not be exceeded.

## ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

Fig.1 Input Voltage vs. Output Current (ON Characteristics)

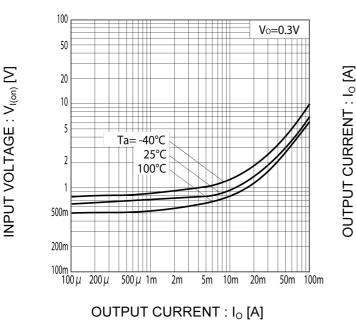
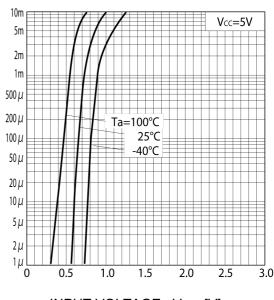


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)



INPUT VOLTAGE :  $V_{I(off)}[V]$ 

Fig.3 Output Current vs. Output Voltage

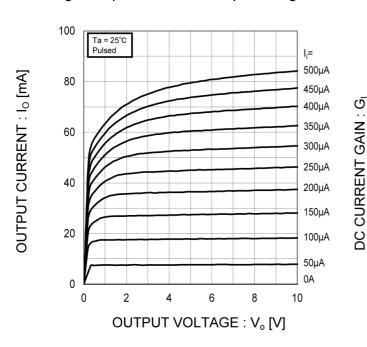
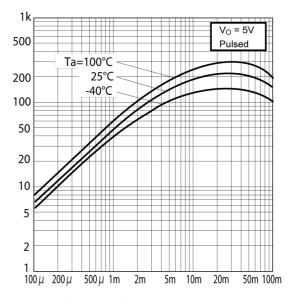


Fig.4 DC Current Gain vs. Output Current

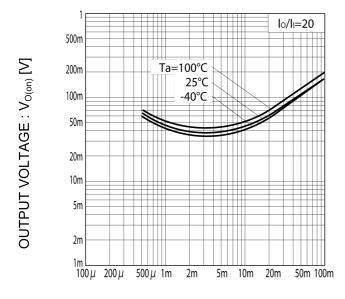


OUTPUT CURRENT: Io [A]

# ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

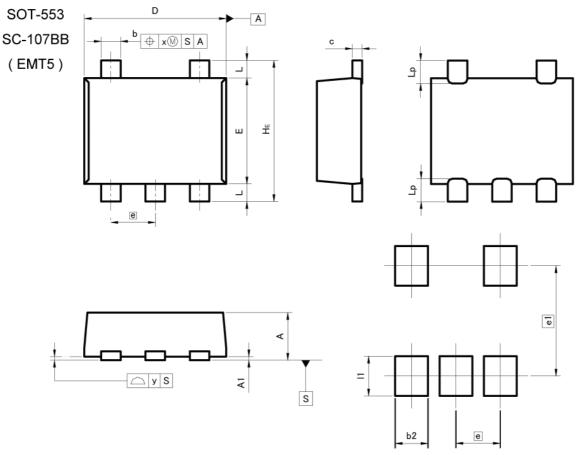
<For DTr1 and DTr2 in common>

Fig.5 Output Voltage vs. Output Current



OUTPUT CURRENT :  $I_o$  [A]

## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

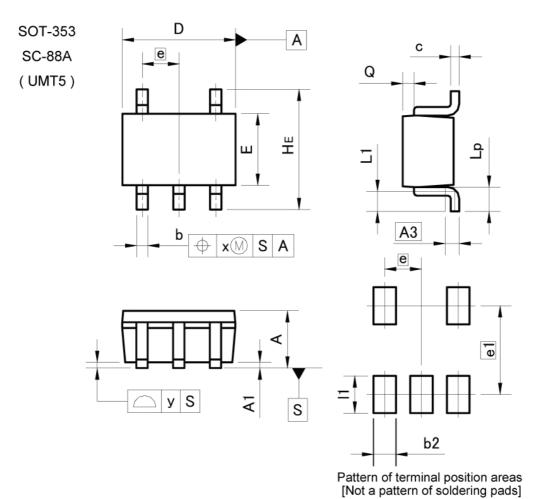
DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
е	0.	50	0.020	
HE	1.50	1.70	0.059	0.067
L	0.10	0.30	0.004	0.012
Lp	-	0.35	-	0.014
х	_	0.10	_	0.004
У	_	0.10	_	0.004

DIM	MILIMETERS		INCHES		
DIW	MIN MAX		MIN	MAX	
b2	-	0.37	ı	0.015	
e1	1.25		0.0	49	
11	- 0.45		-	0.018	

Dimension in mm/inches



## Dimensions



DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.5	25	0.0	10
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.026	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.020
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	-	0.10	, <del>-</del>	0.004
У	-	0.10	e <del></del>	0.004

MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX
b2	- 1	0.40	-	0.016
e1	1.55		0.0	61
11	-	0.65	-	0.026

Dimension in mm/inches



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JÁPAN	USA	EU	CHINA
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CLASSIV	CLASSⅢ	CLASSIII	CLASSⅢ

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
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  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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